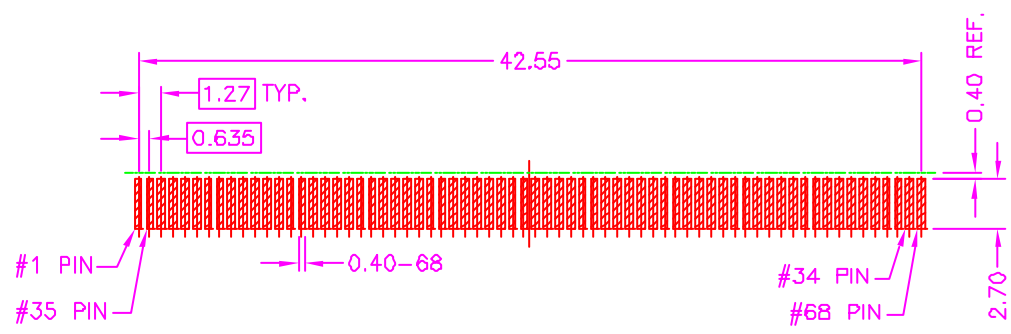
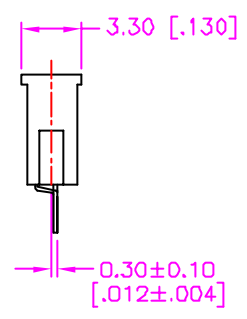
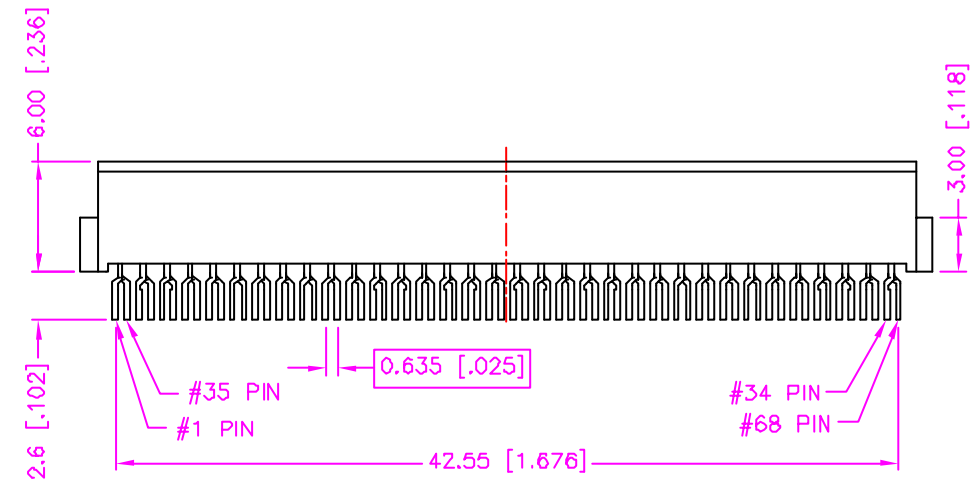
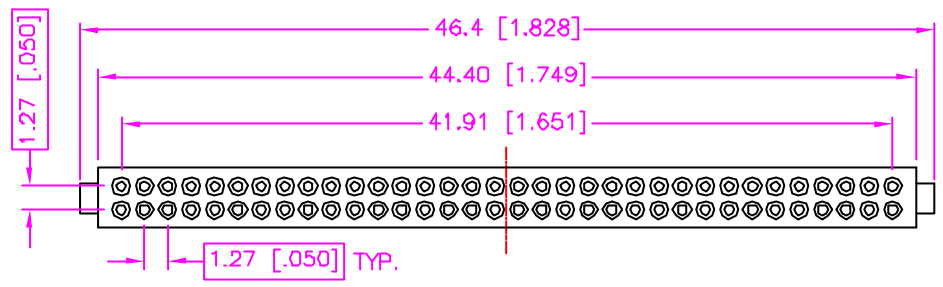


REV.	DESCRIPTION	DATE
—	RELEASE	Jun. 30, 2003
1	DRAW MODIFY	Jul. 01, 2003
2		



RECOMMEND P.C.B. LAYOUT  
TOP VIEW

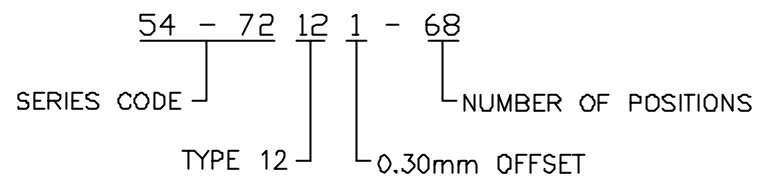
**MATERIALS**

1. HOUSING : HI.-TEMP. PLASTIC (UL 94V-0), BLACK.
2. TERMINAL : COPPER ALLOY, GOLD PLATING ON CONTACT AREA, TIN PLATING ON SOLDER TAIL. (t=0.10mm)

**SPECIFICATION**

1. CURRENT RATING : 0.5 AMP. MAX.
2. DIELECTRIC WITHSTANDING VOLTAGE : 500V AC R.M.S. FOR ONE MINUTE.
3. INSULATION RESISTANCE : 1000M OHMS MIN. AT 500V DC.
4. CONTACT RESISTANCE : 40m OHMS MAX.
5. OPERATING TEMPERATURE : -20°C ~ +60°C.
6. DURABILITY : 10,000 CYCLES.
7. MAX. PROCESSING TEMP. : 230°C FOR 30 ~ 60 SECONDS.

**ORDER INFORMATION :**



TOLERANCE .0=±0.30 [.012] .00=±0.20 [.008] .000=±.XXX .0000=±. ANG.=±3°	DRAWER <i>SUB</i> CHECK <i>Katherlin</i> APP'D <i>LSON</i>	<p>ASTRON TECHNOLOGY CORP.</p>
<p>UNITS : mm [inch]</p>	<p>PRODUCT SPEC.</p> <p>NAME MEMORY CARD PC CARD, 1.27mm PITCH SMT TYPE, FEMALE 0.30mm OFFSET</p>	
SCALE NONE	SIZE A4	SHEET 1 OF 1
REV. B	DRAW NO. C254-7216	03006